DECLARATION - USA PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND APPARATUS FOR SUPPORTING A SEMICONDUCTOR WAFER DURING PROCESSING the specification of which:

- (a) is attached hereto; or
- (b) X was filed on January 8, 1999 as Application No. 09/227,564; or
- (c) X was described and claimed in PCT International Application No. PCT/NL97/00398 filed on July 8, 1998.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) listed below and have also identified below any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed for the same subject matter having a filing date before that of the application(s) of which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

COUNTRY (OR INDICATE IF PCT)	APPLICATION NUMBER	DATE OF FILING (day, month, year)	PRIORITY CLAIMED UNDER 37 U.S.C. §-119	
The Netherlands	1003538	08/07/96	X YES NO 🔾	
			□ YES NO □	
			☐ YES NO ☐	
			□ YES NO □	
			☐ YES NO ☐	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S.A. Application(s)

Application No.:	Filing Date:		Status:	
I hereby declare that made on information and be knowledge that willful false st Section 1001 of Title 18 of the of the application or any paten	lief are believed to be atements and the like se United States Code ar	true; and furthe o made are punis	hable by fine or imprisonn	ere made with the
Full name of sole or first inver	1/	***	en frankriger ander en en en 1900 – 1900 – 1900 – 1900 1	
Inventor's signature	Mr	11Month	June Year 1999	
Residence (city and country): Citizenship: Dutch Post Office Address: Same as		., NL-1217 AD Н	IILVERSUM, The Netherla	ands
Full name of second inventor:		11 Month	June Year 1999	
Residence (city and country):	and the second s			
Citizenship: Dutch Post Office Address: Same as	above			

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